intel

Product Change Notification

Change Notification #: 118615-00

Change Title: Select Intel® RAID Adapter RSP3WD080E,

Intel® Storage Adapter RSP3GD016J, Intel® Storage Adapter RSP3QD160J, Intel® RAID Maintenance Free Backup

AXXRMFBU6,

Intel® RAID Maintenance Free Backup

AXXRMFBU4,

Intel® RAID Controller RS3DC080, Intel® RAID Maintenance Free Backup

AXXRMFBU5,

Intel® Integrated RAID Module RMS3CC080, Intel® Integrated RAID Module RMS3JC080, Intel® Integrated RAID Module RMS3HC080,

PCN 118615-00, Product Discontinuance,

End of Life

Date of Publication: October 25, 2021

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

| - <u></u> | |
|--|--------------------|
| Product Discontinuance Program Support Begins | October 25, 2021 |
| Last Product Discontinuance Order Date | September 16, 2022 |
| Orders are Non-Cancelable and Non-Returnable After | June 17, 2022 |
| Last Product Discontinuance Shipment Date | May 17, 2023 |

Description of Change to the Customer:

The Intel SKUs listed in the products affected table will End of life.

Customer Impact of Change and Recommended Action:

Determine your remaining demand for this product and order accordingly.

Intel reserves the right to extend the Last Product Discontinuance Shipment Date based on manufacturing capabilities and supply availability.

The recommended replacement SKUs are noted within the affected products table within this PCN notice but Intel recommends to contact your local Intel Field Sales Representative as form factor may be different and additional options will be available at a later date.

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Please contact your local Intel Field Sales Representative if you have any further questions about the product transition or End of Life process.

Products Affected/Intel Ordering Codes:

| Marketing Name | Product Code | Affected MM# | Recommended replacement Product Code | Recommended replacement MM# |
|---|---------------------|-----------------|--|-----------------------------|
| Intel® Integrated RAID Module RMS3HC080, Single | RMS3HC080 | 932469 | RS3P4TF160F | 999TJ4 |
| Intel® Integrated RAID Module RMS3JC080, Single | RMS3JC080 | 932472 | RS3P4TF160F | 999TJ4 |
| Intel® Integrated RAID Module RMS3CC080, Single | RMS3CC080 | 932474 | RS3P4TF160F | 999TJ4 |
| Intel® RAID Maintenance Free Backup AXXRMFBU5, Single | AXXRMFBU5 | 933907 | | |
| Intel® RAID Controller RS3DC080, Single | RS3DC080 | 934643 | RS3P4TF160F | 999TJ4 |
| Intel® RAID Maintenance Free Backup AXXRMFBU4, Single | AXXRMFBU4 | 937318 | | |
| Intel® RAID Maintenance Free Backup AXXRMFBU6, 5 Pack | AXXRMFBU6 | 945975 | | |
| Intel® Storage Adapter RSP3QD160J, 5 Pack | RSP3QD160J | 954491 | RS3P4QF160J | 999RKM |
| Intel® Storage Adapter RSP3GD016J, 5 Pack | RSP3GD016J | 954492 | RS3P4GF016J | 999TJ3 |
| Intel® RAID Adapter RSP3WD080E, 5 Pack | RSP3WD080E | 954495 | RS3P4TF160F | 999TJ4 |
| Intel® Integrated RAID Module RMS3CC080, Single | RMS3CC080 | 999L36 | RS3P4TF160F | 999TJ4 |

PCN Revision History:

Date of Revision: Revision Number: Reason:

October 25, 2021 00 Originally Published PCN

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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